



NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE0140IA uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

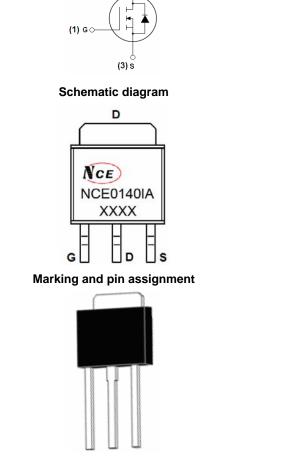
General Features

- $V_{DS} = 100V, I_D = 40A$ $R_{DS(ON)} < 17m\Omega @ V_{GS} = 10V$ (Typ:12m Ω) $R_{DS(ON)} < 18m\Omega @ V_{GS} = 4.5V$ (Typ:13m Ω)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED! 100% ΔVds TESTED!



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TO-251 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0140IA	NCE0140IA	TO-251	-	-	-

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	100	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	Ι _D	40	А	
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	28	А	
Pulsed Drain Current	I _{DM}	160	А	
Maximum Power Dissipation	PD	140	W	
Derating factor	-	0.93	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	400	mJ	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C	





NCE0140IA

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2) R _{0JC} 1.07 °C/W

Electrical Characteristics (Tc=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	100	110	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)			•				
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	0.9	1.1	1.5	V	
Drain Course On State Desistance		V _{GS} =10V, I _D =20A	-	12	17		
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =20A	- 13 18		18	mΩ	
Forward Transconductance	g fs	V _{DS} =5V,I _D =20A	32	-	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}		-	3400	-	PF	
Output Capacitance	C _{oss}	V _{DS} =30V,V _{GS} =0V, F=1.0MHz	-	290	-	PF	
Reverse Transfer Capacitance	C _{rss}		-	221	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	15	-	nS	
Turn-on Rise Time	tr	V _{DD} =30V,I _D =2A,R _L =15Ω,	-	11	-	nS	
Turn-Off Delay Time	t _{d(off)}	R _G =2.5Ω,V _{GS} =10V	-	52	-	nS	
Turn-Off Fall Time	t _f		-	13	-	nS	
Total Gate Charge	Qg		-	94	-	nC	
Gate-Source Charge	Q _{gs}	I _D =20A,V _{DD} =50V,V _{GS} =10V	-	16	-	nC	
Gate-Drain Charge	Q _{gd}		-	24	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	0.85	1.2	V	
Diode Forward Current (Note 2)	I _S		-	-	40	Α	
Reverse Recovery Time	trr	T _J = 25°C, I _F = 20A	-	33		nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	54		nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				y LS+LD)	

Notes:

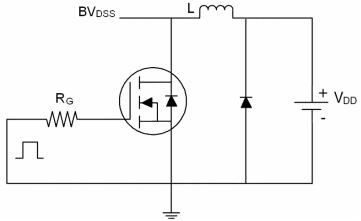
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ \! \mathbb{C}$,V_{DD}=50V,V_G=10V,L=0.5mH,Rg=25\Omega



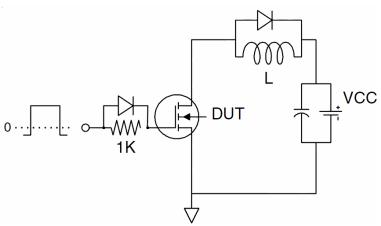
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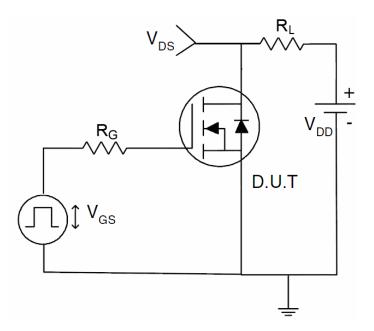
Test Circuit 1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit



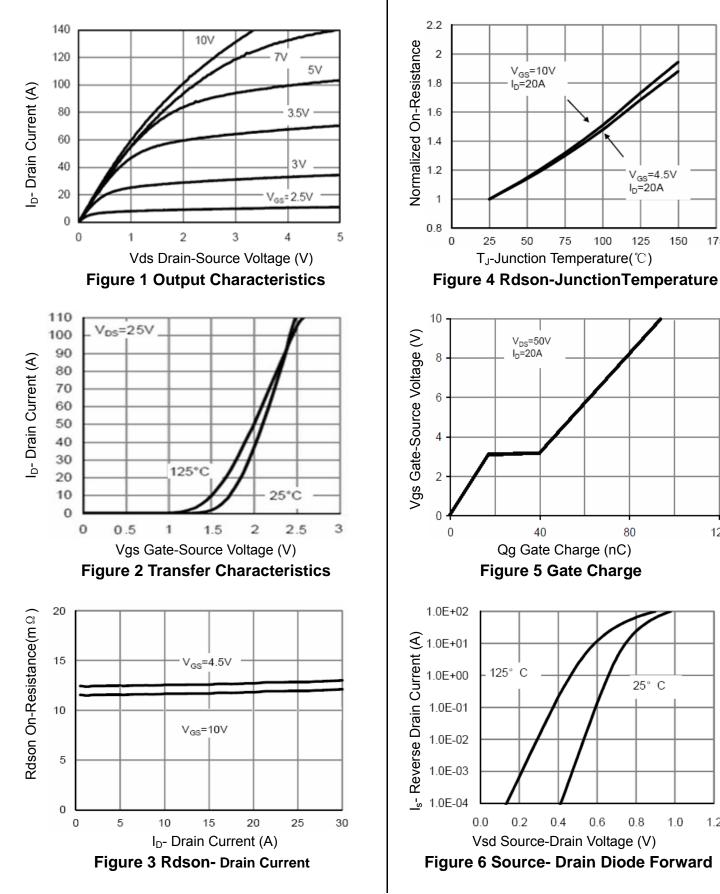




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120

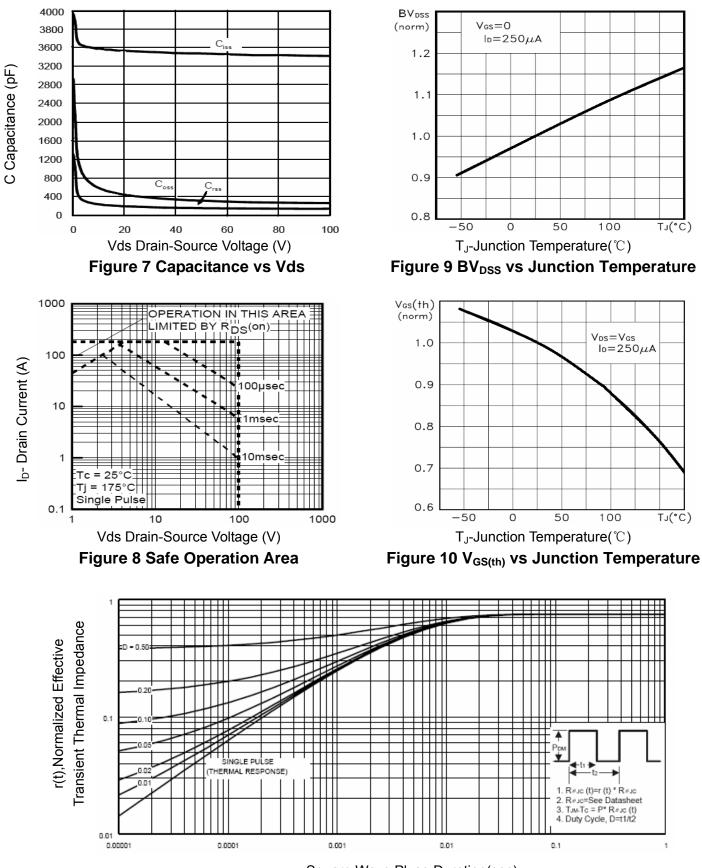
Typical Electrical and Thermal Characteristics (Curves)

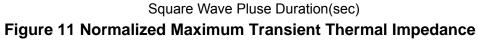


1.2







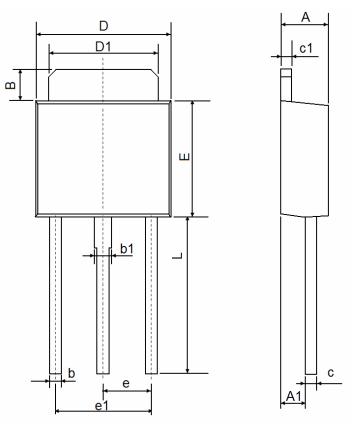




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TO-251 Package Information



Symbol	Dimensions	s In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	1.050	1.350	0.042	0.054	
В	1.350	1.650	0.053	0.065	
b	0.500	0.700	0.020	0.028	
b1	0.700	0.900	0.028	0.035	
С	0.430	0.580	0.017	0.023	
c1	0.430	0.580	0.017	0.023	
D	6.350	6.650	0.250	0.262	
D1	5.200	5.400	0.205	0.213	
E	5.400	5.700	0.213	0.224	
е	2.300 TYP		0.091 TYP		
e1	4.500	4.700	0.177	0.185	
L	7.500	7.900	0.295	0.311	





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